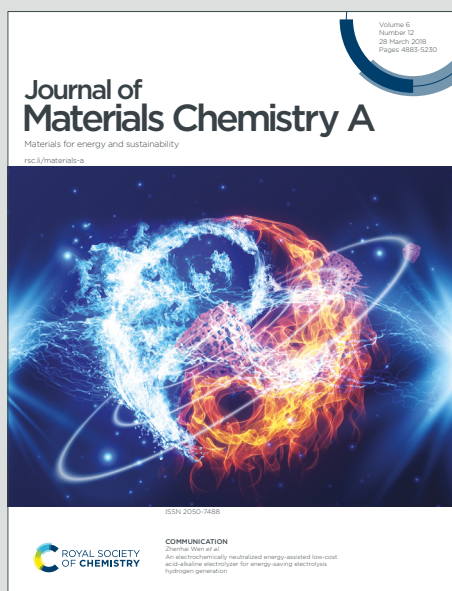


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1 **Design of Array Structure for Carbon-based Field-Effect-**
2 **Transistor Type Gas Sensor to Accurately Identify Trace Gas**
3 **Species**

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9 **Highlight :**

- 10 a) A carbon-based field effect transistor gas sensor with a gas-sensing gate is
11 proposed to detect trace gas.
- 12 b) Using the noble metal nanoparticles/ Co_3O_4 composites as the sensing gate ensures
13 that the detection limit of gas sensor toward toluene is as low as 80 ppb.
- 14 c) A carbon-based field effect transistor sensor array with different gas sensing gates
15 is designed to achieve accurate recognition of gas.

16

17 **Abstract**

18 The accurate identification of trace gases has become an important subject in the
19 field of environmental monitoring due to the ppb-level permissible upper limit of indoor
20 harmful gases. However, there are two challenges in trace gas detection, namely, the
21 signal caused by the gas sensor is weak due to the extremely low concentration of trace
22 gas, and the response signal of the target gas may be interfered by other gases owing to
23 the crossing-sensitivity of materials. Herein, a carbon-based field effect transistor (FET)
24 gas sensor array based on multi-sensing gates is presented. Based on the intrinsic
25 amplifying effect of the field effect transistor, the proposed carbon-based FET-type gas
26 sensor unit can detect the weak signal generated by 80 ppb gas at room temperature.
27 Through the construction of the carbon-based FET gas sensor array structure with
28 multi-sensing gates, the correlations between multiple parameters and gas species and
29 concentrations are established, so as to realize the purpose of identifying the single
30 unknown gas with an accuracy of 97.51%. This work provides a new strategy to develop
31 micro gas sensor chips for accurate detection toward trace gases at room temperature.

32 **Key words** : Carbon-based FET gas sensor; Gas sensing gate; Gas sensor array;
33 Trace gas detection; Gas identification

34 Introduction

35 Indoor volatile organic compounds (VOCs), which are released in large quantities
36 by paint, cleaning products and furniture, seriously affect our health, causing severe
37 diseases such as asthma, hearing loss and mental impairment [1-3]. According to the
38 European air quality guidelines issued by the WHO, the upper allowable concentration
39 of the indoor harmful gas is at the ppb level [4]. This means that the detection of trace
40 gas has become an important research direction in the field of gas sensor. At present,
41 the fundamental reason why trace gases are difficult to detect is that the electrical signal
42 generated by trace gas molecules is too weak to be effectively captured due to too few
43 adsorbed gas molecules on the sensing materials [2,5-7]. Moreover, the gas sensing
44 property of the gas sensor is prone to interference from other gases in the environment,
45 due to the similarity of the sensing mechanism between sensing materials and various
46 gases [8,9]. And the sensing signal generated by a gas sensor is single, which makes it
47 difficult to realize the comprehensive evaluation of gas species and concentrations.
48 How to realize the effective amplification of weak signal caused by trace gases and how
49 to improve the discrimination ability of gas sensor toward target gas become the key
50 bottleneck issues to achieve accurate detection of trace target gas.

51 With the emergence of nanomaterials and the rapid development and application
52 of semiconductor device manufacturing technology, the field effect transistor (FET) has
53 attracted wide attention in the field of building highly sensing and integrated sensors
54 because of its advantages such as high reliability, small size, good compatibility with
55 CMOS technology and easy mass preparation [10-13]. In particular, the amplification

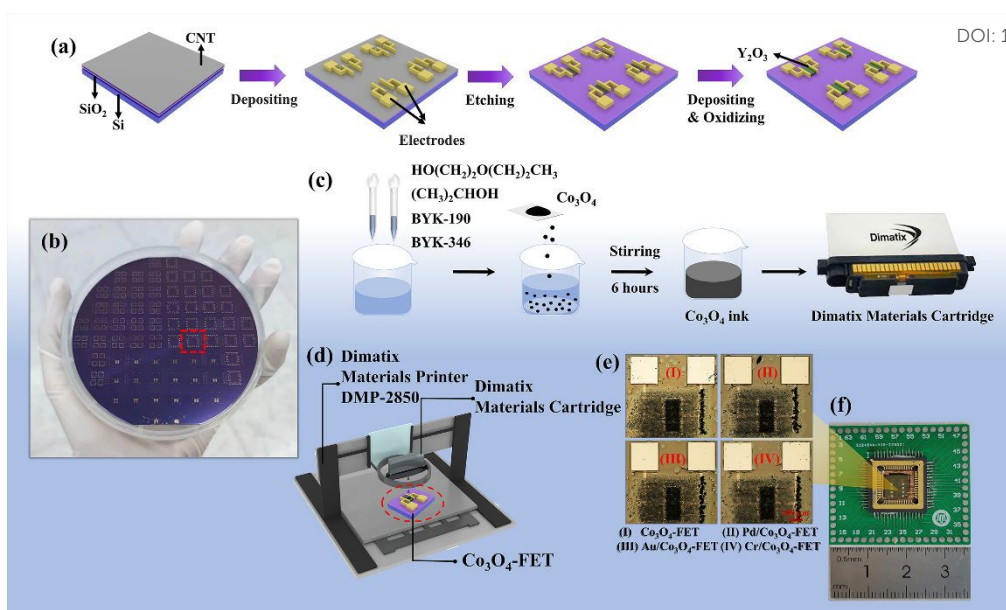
56 effect of the FET makes it easy for the FET-type gas sensor to capture the weak signal
57 caused by the trace gas [5], which is expected to realize the effective detection of trace
58 gas. Generally, for MOSFET, the carrier concentration in channel can be adjusted by
59 the electrical signal on gate, and the excellent electrical property of the FET is the
60 premise to ensure the effective amplification of weak signal on the gate of FET-type
61 gas sensor [14], among which the channel material is one of the key factors determining
62 the electrical performance of the FET [15-17]. At present, the information
63 industrialization development of FETs has gradually entered the beyond-Moore era.
64 According to relevant reports, semiconductor carbon nanotubes (CNTs) are considered
65 to be very potential channel materials for the construction of the next generation FET
66 because of their atomic thickness bodies, tunable bandgap and ultrahigh carrier mobility
67 [18-23]. Moreover, compared with silicon-based FET, the preparation process of
68 carbon-based FET is relatively simple [23], such as without the ion implantation
69 process, which brings more development and opportunities for FET in the field of
70 sensor.

71 In practical applications, it is difficult to accurately identify of gas concentration
72 and species by a single gas sensor due to the strong cross-sensitivity of gas sensing
73 materials. An effective strategy to construct a variety of signal parameters can be
74 adopted to evaluate gas concentration and species [8]. Lu et al. effectively adjusted the
75 selectivity of the sensor by introducing the noble metal nanoparticles (NMNPs) to
76 modify In_2O_3 (NWs), and effectively and simultaneously distinguished different
77 exhaled breath biomarkers by constructing a gas sensor array based on a variety of

78 NMNPs /In₂O₃ NWs [24]. The introduction of different NMNPs can effectively adjust
79 the selectivity of the gas sensor toward the gas. Through the construction of the gas
80 sensor array with different sensing gates, the various gas sensing parameters outputted
81 by different gas sensor units can be obtained to comprehensively evaluate the
82 concentration and species of gas [25-27]. However, the gas sensor array composed of
83 multiple side-heating gas sensors has the disadvantages of large volume, overworking
84 temperature and high-power consumption, which is unfavorable to the miniaturization
85 development and portable application of gas sensors. Therefore, realizing the
86 miniaturization and low power consumption of sensor array will benefit its application
87 in the field of gas recognition.

88 In this work, CNTs are used as the channel of the FET device, and the wafer-scale
89 preparation of the FET gas sensing platform is realized on a 4-inch wafer covered with
90 random network CNTs. Through the inkjet printing technology and electron beam
91 evaporation (EBE), a carbon-based FET gas sensor array is constructed by depositing
92 different NMNPs/Co₃O₄ composites as sensing gates on carbon-based FET gas sensing
93 platforms. Based on the amplification effect of FET, the gas sensor unit realizes the
94 detection of toluene gas at ppb-level concentration. The identification of gas
95 concentration and species is realized through the design of multi-sensing gates gas
96 sensor array structure, which provides a new strategy for the development and
97 application of sensor array in trace gas identification.

98 **Experimental**



99

100 **Fig. 1** (a) Fabrication process diagram of the carbon-based FETs. (b) Optical image of the wafer-
 101 scale devices array composed of FETs with various structures. Marked by the wire frame is the
 102 floating-gate FET gas sensing platform required for subsequent gas sensing experiments. (c)
 103 Configuration process diagram of the Co_3O_4 ink. (d) Diagram of the inkjet printing process, marked
 104 by the wire frame is the Co_3O_4 -FET that is depositing the gate sensing layer. (e) Optical image of
 105 four kinds of floating-gate FET gas sensor units. (f) Photograph of the packaged sensor.

106 In this work, the carbon-based wafer is fabricated by coating the CNTs on a 4-inch
 107 Si/SiO₂ substrate to form a film by dip-coating method, and the detailed experimental
 108 procedures can refer to the work of Zhang's research team from Peking University
 109 [9,23]. The wafer-scale carbon-based FETs are fabricated by ultraviolet lithography
 110 (EVG 610, Austria), reactive ion etching (RIE, Haasrode-R200A, China) and EBE
 111 (DE400). The detailed fabrication process and optical images of the FET device are
 112 schematically illustrated in Fig. 1a. Firstly, the source (S) and Drain (D) electrode
 113 regions are defined on a 4-inch CNTs wafer by photolithography, and Ti/Pd/Au (0.3
 114 nm/20 nm/40 nm) thin films are deposited by EBE at the rates of 0.1 Å/s, 1.0 Å/s and

115 1.0 Å/s, respectively. Secondly, in order to prevent the mutual interference between the
116 sensors, the excess CNTs are etched under oxygen plasma for 60 s by photolithography
117 and RIE to form a channel with a length of 300 μm and a width of 600 μm. An yttrium
118 (Y) film with the thickness of 3 nm is deposited over the S/D electrode and channel by
119 EBE at a low rate of 0.1 Å/s, and then thermally oxidized in air at 270°C for 30 min.
120 Repeat the preceding operations one more time, an ultra-thin yttrium oxide (Y₂O₃) layer
121 (thickness: ~12 nm, length: 800 μm, width: 1200 μm) is formed on the channel and S/D
122 electrodes as the gate oxide layer of the FET. Finally, the wafer-scale devices array
123 composed of FETs with various structures is successfully prepared by photolithography
124 as shown in Fig. 1b, where the red wire frame area is the floating-gate FET gas sensing
125 platform required for subsequent gas sensing experiments. The size of a single FET
126 device is 1.4 mm in width and 1.5 mm in length.

127 In order to be compatible with CMOS technology and realize mass preparation of
128 sensors, the inkjet printing technology is used to uniformly and controllably deposit the
129 sensing materials on the micron-sized floating-gate FET gas sensing platform [28-30].

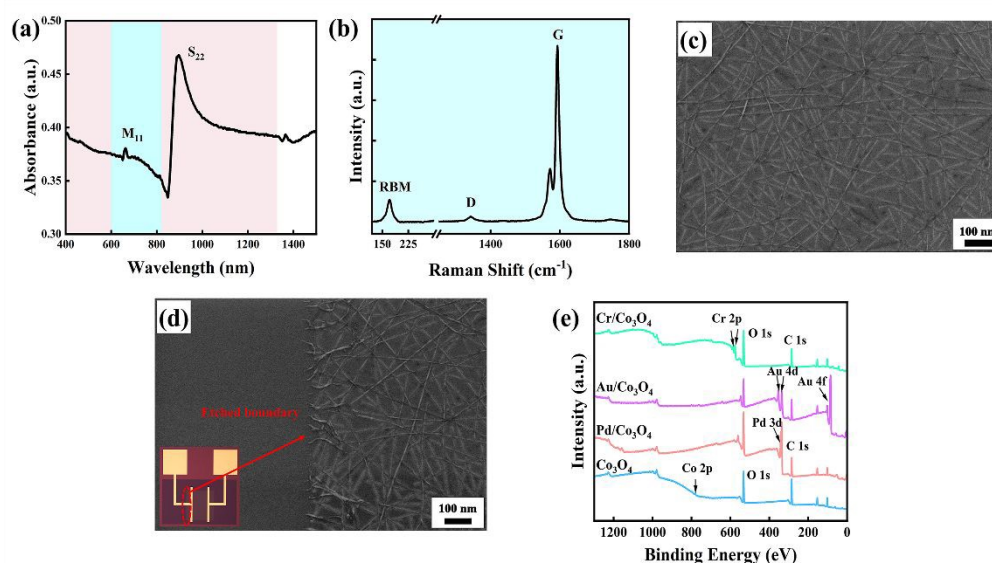
130 In this work, the chemical reagents related to the preparation of inkjet printing ink are
131 purchased from Aladdin Biochemical Technology Co., LTD. (Shanghai, China), and
132 are not further purified. The preparation process diagram of the Co₃O₄ ink is shown in
133 Fig. 1c. Firstly, 1.2 g Co₃O₄ nanoparticles (size: ~50 nm) is dissolved in the mixed
134 solution composed of ethylene glycol propyl ether (HO(CH₂)₂O(CH₂)₂CH₃, 10 ml),
135 isopropyl alcohol ((CH₃)₂CHOH, 10 ml), dispersive agent BYK-190 (1 ml) and
136 organosilicone surfactant BYK-346 (1 ml). Then, the Co₃O₄ ink is obtained by magnetic

137 stirring at room temperature ($\sim 25^\circ\text{C}$) for 6 hours. After 2 ml Co_3O_4 ink is filled into the
138 ink cartridge (Dimatix Materials Cartridge), a layer of Co_3O_4 film is printed on the gate
139 region exposed in advance by lithography of the prepared floating-gate FET gas sensing
140 platform by the materials printer (Model: DMP-2850, Fujifilm, America, Substrate
141 temperature: 50°C , Drop spacing: $25\ \mu\text{m}$, Drop volume: $10\ \text{pL}$, Print time: once) as
142 shown in Fig. 1d, then the deposited film is annealed on a heater at 200°C for 15 min
143 to form a gas sensing gate, and finally the carbon-based FET Co_3O_4 gas sensor is
144 obtained as shown in Fig. 1e (III). In addition, in order to construct a floating-gate FET
145 gas sensor array with multiple sensing gates, Pd, Au and Cr nanoparticles with a
146 thickness of 1 nm are deposited respectively at the rate of $0.1\ \text{\AA}/\text{s}$ on the surface of
147 Co_3O_4 by EBE to prepare four kinds of floating-gate FET gas sensor units as shown in
148 Fig. 1e, which are defined as (I) Co_3O_4 -FET, (II) Pd/ Co_3O_4 -FET, (III) Au/ Co_3O_4 -
149 FET and (IV) Cr/ Co_3O_4 -FET, respectively. In order to prevent the sensor from being
150 contaminated by dust in the air, the prepared sensors are packaged on the self-made
151 printed circuit board through wire bonding, as shown in Fig. 1f.

152 Ultraviolet-Visible-near-infrared spectroscopy (UV-3600, Shimadzu, Japan) and
153 Raman spectroscopy (Renishaw in Via, UK) are performed to verify the purity of the
154 CNTs film. The surface morphologies of CNTs film and sensing materials are
155 investigated by field emission scanning electron microscopy (FE-SEM, Hitachi
156 SU5000, Japan). The material compositions of sensing materials are characterized by
157 X-ray photoelectron spectroscopy (XPS, Thermo ESCALAB 250Xi). The electrical
158 properties of the floating-gate FET gas sensors are measured using a Keithly 4200

159 semiconductor analyzer combined with a probe stand (Cascade Microtech MPS 150).
 160 As shown in Fig. S1a, the gas sensing measurement platform is composed of DGL-III
 161 humidity control gas-liquid distribution system, test chamber, and CGS-MT intelligent
 162 gas-sensing analysis system (Beijing Elite Tech Co., Ltd., China). Fig. S1b exhibits the
 163 corresponding digital photo. The gases required for the gas sensing test are purchased
 164 from Dalian Special Gas Co., Ltd. (Dalian, China) and calibrated with the Fourier
 165 Transform infrared spectrometer (Spectrum 100). The MFC1 (maximum flow rate:
 166 1000 sccm) and MFC2 (maximum flow rate: 100 sccm) of the DGL-III are used to
 167 control the flow rate of the air and the high concentration target gas, respectively, to
 168 synthesize the target gas (C₇H₈, HCHO, C₆H₆, NH₃, NO₂) with different concentrations
 169 required by the experiment. The Response is defined as the $\text{Response} = \frac{I_g - I_a}{I_a} \times 100\%$,
 170 where I_g and I_a are the currents of the sensor in the target gas and air, respectively [31].
 171 The response and recovery times are expressed as the time required for the gas sensing
 172 current change to reach 90% of the total current change [32].

173 Results & Discussion



174

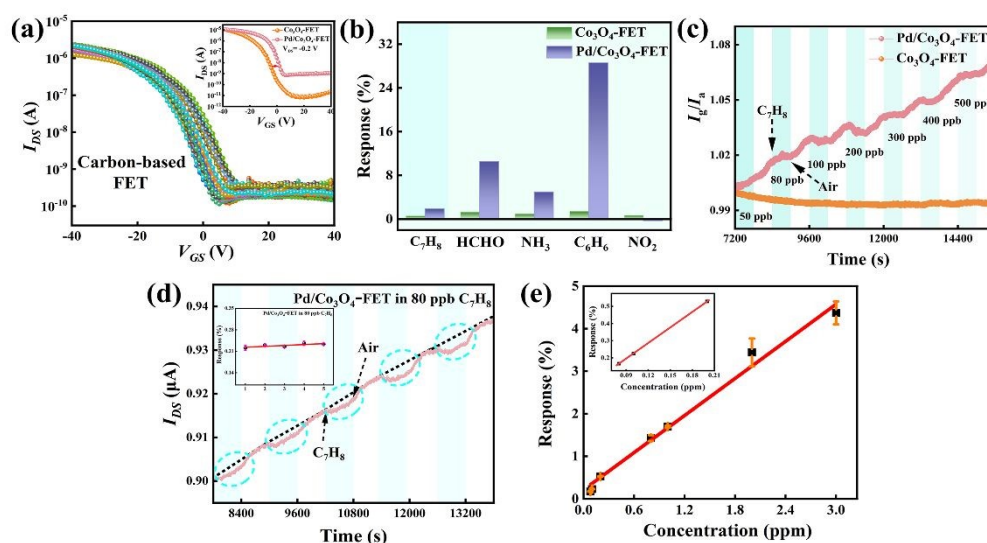
175 **Fig. 2** (a) UV–vis–NIR absorption spectra and (b) Raman spectra of the CNTs film. FE-SEM images
176 of (c) the CNTs film and (d) the channel region after etching. (e) Full XPS spectra of Co_3O_4 ,
177 $\text{Pd}/\text{Co}_3\text{O}_4$, $\text{Au}/\text{Co}_3\text{O}_4$ and $\text{Cr}/\text{Co}_3\text{O}_4$.

178 It is well known that the high-quality channel material is the key to the construction
179 of FET with good electrical property [23,33]. Therefore, a series of characterizations of
180 CNTs films of floating-gate FET are firstly carried out, as shown in Fig.2. Fig. 2a
181 exhibits the absorption spectra of the CNTs film in the range of 400-1500 nm. The
182 peaks of M_{11} and S_{22} can be observed at 600-800 nm and 820-1350 nm, respectively.
183 The characteristic peaks of M_{11} and S_{22} indicate the existence of metallic and
184 semiconductor fractions in CNTs, respectively. Compared with the weak M_{11} peak, the
185 intensity of the S_{22} peak is much stronger, indicating the high semiconducting purity of
186 the CNTs [34-37]. In order to further characterize the quality of CNTs film, the Raman
187 spectra of CNTs film is obtained, as shown in Fig. 2b. The peaks D and G at 1340 and
188 $\sim 1590\text{ cm}^{-1}$ are the typical Raman characteristic peaks of the CNTs [38]. The higher
189 I_G/I_D ratio indicates that the CNTs used in this work have fewer defects [39,40], which
190 ensures the good electrical properties of the FET, such as high carrier mobility [41,42].
191 In addition, it can be seen from Fig. 2b that a radial respiration mode (RBM) peak
192 appears at 170 cm^{-1} [43]. According to the experimental relationship of $\omega = 248/d$ (nm)
193 (ω and d are the RBM Raman shift and the CNTs diameter, respectively), the diameter
194 of the CNTs is distributed around 1.5 nm [39], which is shown that the thickness of the
195 channel composed of CNTs is in atomic dimension. Fig. 2c shows the FE-SEM image
196 of the carbon-based wafer. The CNTs are distributed uniformly and densely in a random

197 network on the Si/SiO₂ substrate, which means that the carbon-based FET can be
198 prepared on the CNTs wafer without positioning, providing the support for the
199 preparation of the wafer-scale carbon-based FETs. The FE-SEM image of the CNTs
200 channel boundary etched by reactive ion etching is shown in the Fig. 2d. A sharp
201 boundary can be observed between the channel region and the etched region. After the
202 etching process, the left etched region is very clean without residual CNTs, and the
203 CNTs in the right channel region are not affected, indicating that the channel region is
204 formed successfully by a controllable and accurate etching process.

205 In order to characterize the elemental composition and chemical state of the
206 materials, the surface chemical analyses of Co₃O₄ and three NMNPs/Co₃O₄ materials
207 composites are performed by XPS. Fig. 2e exhibits the full XPS spectra of Co₃O₄ and
208 Pd, Au and Cr modified Co₃O₄, Pd/Co₃O₄, Au/Co₃O₄ and Cr/Co₃O₄ contain Pd, Au and
209 Cr peaks respectively in addition to the peaks of Co, O and C in Co₃O₄, confirming the
210 successful modification of the three NMNPs, where all binding energy values in the
211 XPS spectra are calibrated with a peak of C 1s (284.8 eV). Fig. S2 depicts the high-
212 resolution XPS spectra of Pd 3d, Au 4f and Cr 2p respectively, which is used to
213 determine the valence states of Pd, Cr and Au. The XPS high-resolution spectra of Pd
214 3d are of three peaks, which are related to Pd 3d_{3/2} and Pd 3d_{5/2}, respectively. The double
215 peaks fitted by Pd 3d_{5/2} are located at 336.1eV and 337.9eV, corresponding to Pd²⁺ and
216 Pd⁰, respectively [44]. The presence of Pd²⁺ indicates the presence of PdO in the
217 Pd/Co₃O₄, but the amount is rarely negligible [45-47]. The two peaks of Au 4f at 88.1
218 eV and 84.42 eV correspond to Au 4f_{5/2} and Au 4f_{7/2} states, and the two peaks of Cr 2p

219 at 586.6eV and 577 eV belong to Cr 2p_{1/2} and Cr 2p_{3/2}, respectively. The binding energy
 220 differences between the peaks of Au 4f and Cr 2p are 5.3 eV and 3.78 eV, respectively,
 221 confirming that the Au and Cr nanoparticles are not oxidized. These features are
 222 consistent with the binding energies of metallic Au and Cr reported in the literature [48-
 223 51].



224
 225 **Fig. 3** (a) Transfer characteristic curves of the carbon-based FET, the inset is the transfer
 226 characteristic curves of the Co_3O_4 -FET and $\text{Pd}/\text{Co}_3\text{O}_4$ -FET, respectively. (b) Comparison of
 227 response values of the Co_3O_4 -FET and $\text{Pd}/\text{Co}_3\text{O}_4$ -FET to different gases. (c) Dynamic
 228 response/recovery curves of the Co_3O_4 -FET and $\text{Pd}/\text{Co}_3\text{O}_4$ -FET at the range of 50-500 ppb C_7H_8 .
 229 (d) Dynamic response curves of the $\text{Pd}/\text{Co}_3\text{O}_4$ -FET at 80 ppb C_7H_8 for five cycles, and the marked
 230 wire frames correspond to the five responses. The inset shows the corresponding response values.
 231 (e) Response fitting curve of $\text{Pd}/\text{Co}_3\text{O}_4$ -FET to C_7H_8 at the range of 50 ppb-3 ppm.

232 As a gas sensing platform, the FET should be fabricated with high yield, reliability,
 233 and performance uniformity. The transfer characteristic curves of the carbon-based
 234 FETs are tested at the V_{GS} range from -40 to +40 V and the V_{DS} of -0.2 V. There is no

235 significant difference in the transfer characteristic curves of randomly selected fifty-
236 five carbon-based FETs, indicating that the wafer-scale carbon-based FETs are highly
237 consistent. All transistors present p-channel depletion FETs, and the current on/off
238 ratios of the transistors are $\sim 10^4$. The inset of Fig. 3a shows the transfer characteristic
239 curves of Co_3O_4 -FET and Pd/ Co_3O_4 -FET gas sensors, respectively. Compared with the
240 carbon-based FET, the transfer characteristic curve of Co_3O_4 -FET is changed due to the
241 changes in the gate oxide layer capacitance of the FET caused by deposition of gate
242 sensing layer [52]. After the deposition of Pd nanoparticles, the transfer characteristic
243 curve of the Co_3O_4 -FET is obviously shifted and the current on/off ratio decreases
244 significantly. This phenomenon is due to the fact that Pd (5.59 eV) [53] is a high-work-
245 function metal and its deposition changes the work function of the gate sensing material,
246 leading to the change in the surface potential and thus changing the threshold voltage
247 of the sensor [54]. As shown in the inset of Fig. 3a, when the gate voltage is 0 V, the
248 carbon-based FET gas sensors are in the on-state, which means that the carbon-based
249 FET sensors can operate without gate voltage, reducing energy consumption.

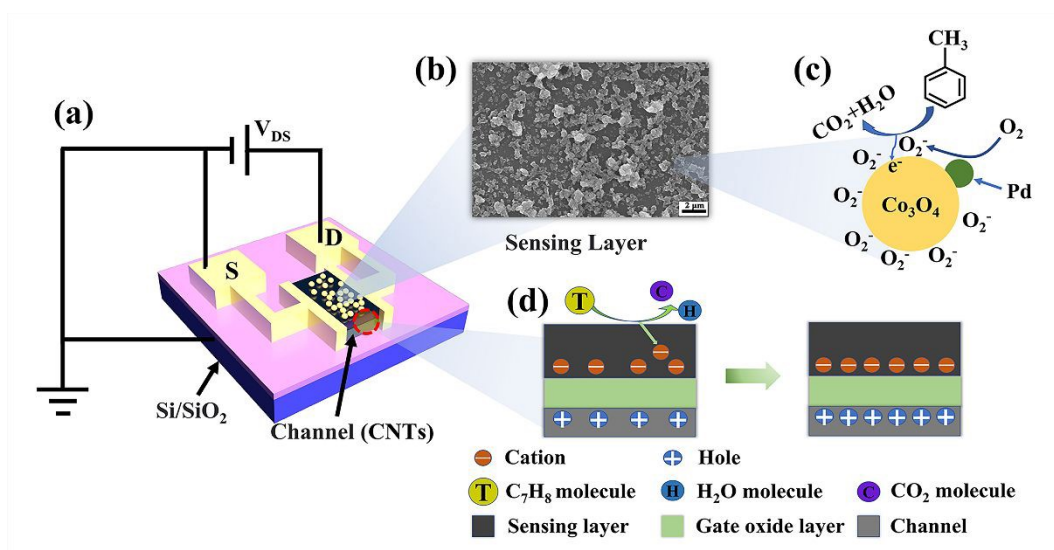
250 Then, the gas sensing property of the gas sensor is detected. In order to avoid the
251 influence of the environment on the experimental results, the subsequent gas sensing
252 performance experiments are carried out at room temperature with the relative humidity
253 (RH) of 0.4%RH in the test chamber. It is well known that selectivity is one of the
254 performance evaluation parameters of gas sensor in practical application. The gas
255 sensing response values of Co_3O_4 -FET and Pd/ Co_3O_4 -FET are tested in different gases
256 (HCHO, C_7H_8 , NH_3 , NO_2 and C_6H_6) at 3 ppm. As shown in Fig. 3b, the Co_3O_4 -FET

257 presents similar weak responses to all gases, making it difficult to distinguish the
258 species of gases. After the introduction of the Pd NMNPs, except for the oxidizing gas
259 NO₂ (almost no response), the responses of the Pd/Co₃O₄-FET to reducing gases HCHO,
260 NH₃, C₇H₈ and C₆H₆ are improved to varying degrees. Among them, and the response
261 of the Pd/Co₃O₄-FET to C₇H₈ is the weakest at the same concentration. In order to prove
262 the ability of FET-type gas sensor to detect trace gases at room temperature, C₇H₈, with
263 the weakest response of the gas sensor, is selected as an example to detect, and analyze
264 its gas sensitivity mechanism. In order to confirm that the gas sensing properties of
265 subsequent experiments are mainly from the gate sensing materials, the dynamic
266 response/recovery curves of carbon-based FET with and without Co₃O₄ sensing layer
267 exposed to C₇H₈ at 3 ppm are tested, as shown in Fig. S3. It can be seen that, when
268 switching from air to C₇H₈, the I_{DS} of the carbon-based FET changes little, while the
269 I_{DS} of the Co₃O₄-FET increases gradually, and decreases with Co₃O₄-FET switching to
270 air environment, confirming that the carbon-based FET does not respond to C₇H₈ and
271 all subsequent gas sensing responses come from the gate sensing materials. In order to
272 evaluate the detection capability of the carbon-based FET-type gas sensor for C₇H₈ at
273 the ppb level, the dynamic response/recovery curves of Co₃O₄-FET and Pd/Co₃O₄-FET
274 towards C₇H₈ at the concentrations of 50-500 ppb are tested, as shown in Fig. 3c. At
275 the room temperature, the I_{DS} of the Co₃O₄-FET exposed to C₇H₈ at the ppb-level
276 concentration does not change significantly, indicating that the Co₃O₄-FET is difficult
277 to detect trace C₇H₈, while the Pd/Co₃O₄-FET shows an obvious gas sensing response
278 to C₇H₈ at 80 ppb, which meets the maximum allowable concentration standard of C₇H₈

279 issued by WHO [55].

280 Fig. 3d further shows the dynamic response/recovery curve of the Pd/Co₃O₄-FET
281 at 80 ppb C₇H₈ for 5 cycles. The marked wire frames correspond to five responses
282 respectively, and the corresponding response values are shown in the inset. As can be
283 seen from Figure 3d, baseline drift exists in the dynamic response/recovery curve. This
284 phenomenon is caused by the fact that there is not enough desorption energy at room
285 temperature for C₇H₈ molecules to be desorbed from the surface of the gas-sensing
286 materials. However, it should be pointed out that the change of the I_{DS} caused by each
287 injection of 80 ppb target gas to the Pd/Co₃O₄-FET is consistent. It can be seen from
288 the inset of Fig. 3d that the Pd/Co₃O₄-FET has basically the same response values to
289 C₇H₈ at the same concentration, which means that the baseline drift will not affect the
290 judgment of the gas sensor's gas-sensing response, and indicates that the Pd/Co₃O₄-FET
291 has good repeatability of trace gas detection. According to the response fitting curve
292 shown in Fig. 3e, the response of Pd/Co₃O₄-FET to C₇H₈ gas increases linearly with the
293 increase of gas concentration. Especially, the response of the sensor to C₇H₈ can be
294 proportional to the gas concentration within the concentration variation range of ppb-
295 level. In addition, Fig. S4 shows relatively stable response signals of the Pd/Co₃O₄-FET
296 exposed to 2 ppm C₇H₈ for 20 days. The error of the ten response signals is 5.24%,
297 indicating that the gas sensor Pd/Co₃O₄-FET has good long-term stability. In order to
298 better exhibit the excellent capability of the Pd/Co₃O₄-FET for trace gas detection, the
299 gas-sensing response of the Pd/Co₃O₄-FET to C₇H₈ (with the weakest response) is
300 statistically compared with other reported C₇H₈ gas sensors based on different gas-

301 sensing materials [56-60], as shown in Table S1. It can be seen that the Pd/Co₃O₄-FET
 302 in this work can realize the detection limit of 80 ppb for C₇H₈ at room temperature,
 303 which is far lower than that of other gas sensors, which confirms that it is a very good
 304 strategy for trace gas detection based on the amplification effect of FET.



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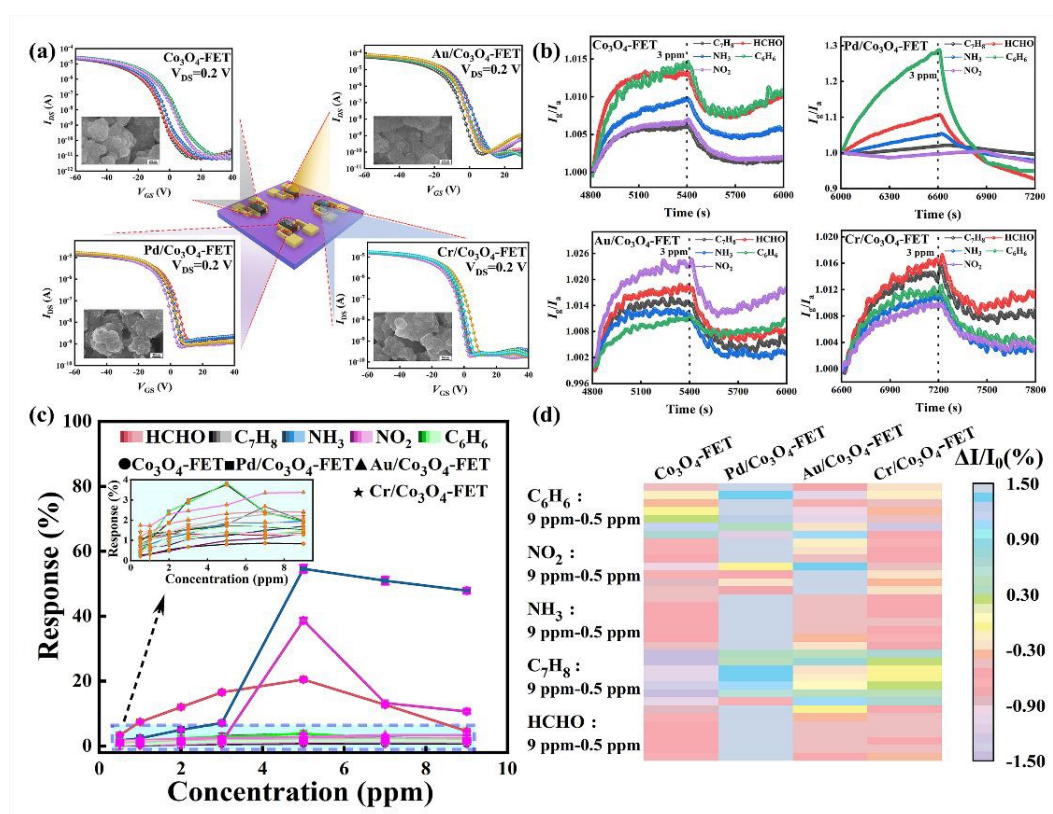
306 **Fig. 4** (a) Test circuit diagram for gas sensing test of the Pd/Co₃O₄-FET sensor. (b) FE-SEM image
 307 of sensing material deposited on the gate area of Pd/Co₃O₄-FET sensor. The sensing mechanism
 308 diagram of the (c) the gas sensing material and (d) the gas sensor.

309 Through the amplification effect of the carbon-based FET and the introduction of
 310 the NMNPs Pd, the Pd/Co₃O₄-FET can detect toluene gas as low as 80 ppb, and the gas
 311 sensing mechanism of the Pd/Co₃O₄-FET is discussed in detail as follows. Fig. 4a
 312 exhibits the schematic diagram of the operating circuit of the Pd/Co₃O₄-FET for gas
 313 sensing test. In this work, a carbon-based FET gas sensor with the floating gate is
 314 prepared. High-purity semiconductor CNTs are used as the channel materials to provide
 315 a high-speed electronic transport channel for the carbon-based FET gas sensor [33].
 316 The gate oxide layer covered on the CNTs separates the channel transport layer from

317 the gate sensing layer so that they can give full play to their respective advantages and
318 form a gas sensor integrating gas detection and signal amplification, which is the main
319 reason for the low detection limit of the gas sensor [10]. The sensing layer deposited on
320 the gate oxide layer is used to realize the gas sensing function. Fig. 4b shows the FE-
321 SEM morphology of the Pd/Co₃O₄ sensing layer. It can be seen that the sensing
322 materials prepared by inkjet printing are uniformly and discretely distributed on the
323 gate oxide layer of the FET. The discontinuity of the sensing materials avoids the
324 possibility that the sensing gate of the FET cannot regulate the channel current due to
325 the short-circuiting of the S/D electrodes. It is also conducive to the gas molecules
326 acting on the three-phase boundaries formed by the gate sensing materials and the gate
327 oxide layer to regulate the channel current of the FET sensor [61,62].

328 As a catalytic metal, Pd nanoparticles have high availability to catalyze the
329 dissociation of molecular oxygen into active oxygen ions. At room temperature, when
330 Pd/Co₃O₄-FET is placed in the air, lots of oxygen molecules are adsorbed on the surface
331 of the sensing materials and catalyzed to decompose into active oxygen ions O₂⁻ (the
332 adsorbed oxygen type is determined by working temperature ~25 °C) [63,64] while
333 capturing electrons of the sensing materials (Fig. 4c) [65,66]. As shown in Fig. 4d, when
334 the Pd/Co₃O₄-FET is exposed to C₇H₈ environment, the trace C₇H₈ gas molecules are
335 catalyzed into small molecules by a large number of active oxygen ions on the surface
336 of Co₃O₄ and the electrons are released [67], which increases the number of the
337 electrons at the interface between the sensing materials and the gate oxide layer. The
338 Pd/Co₃O₄-FET in this work is a P-type FET sensor whose channel current mainly

339 depends on holes, and the holes in the channel are induced to the channel surface due
 340 to the interaction between dipoles, reducing the concentration of holes for conduction
 341 [68,69]. The decrease of the holes in the channel reduces the I_{DS} of the gas sensor, which
 342 is consistent with the response behavior of the Pd/ Co_3O_4 -FET to toluene in the above
 343 experiments.



344
 345 **Fig. 5** (a) Transfer characteristic curves of the four gas sensor units, respectively. The inserts are the
 346 surface topographies of the sensing materials corresponding to the sensors, respectively. (b)
 347 Responses of the four gas sensor units to the five kinds of gases at 3 ppm. (c) Response value curves
 348 of the four gas sensor units to the five kinds of gases at the range of 0.5-9 ppm. (d) Response heat
 349 maps of the four gas sensor units gas sensors to the five kinds of gases.

350 It is noteworthy that the modification of the NMNPs Pd changes the selectivity of
 351 the Co_3O_4 -FET, which gives us an inspiration that the modifications of different

352 NMNPs to the sensing materials are expected to regulate the selectivity of the gas sensor
353 to different gases. Therefore, two other NMNPs, i.e., Au and Cr, are introduced to
354 prepare Au/Co₃O₄-FET and Cr/Co₃O₄-FET, and a carbon-based FET gas sensor array
355 composed of Co₃O₄-FET, Pd/Co₃O₄-FET, Au/Co₃O₄-FET and Cr/Co₃O₄-FET is
356 constructed to comprehensively evaluate the species and concentrations of gases. In
357 order to ensure the consistency of the same gas sensor unit after the metal modification,
358 the transfer characteristic curves of these four kinds of gas sensor units are tested
359 respectively, as shown in Fig. 5a. The insets show the surface topographies of the
360 sensing materials corresponding to the sensors, respectively. It can be seen that the gas
361 sensor units with different modified metals have different transfer characteristic curves
362 due to different work functions of the modified metal, but the same kind of sensors have
363 good consistency. The comparison of dynamic response/recovery curves of the four gas
364 sensor units to five gases at 3 ppm at the same V_{DS} is shown in Fig. 5b. A detailed
365 comparison of the response values is shown in Table S2. It can be seen that the response
366 values of the four gas sensor units to the five gases are significantly different. The
367 Co₃O₄-FET shows similar response to the five gases, while Pd/Co₃O₄-FET, Au/Co₃O₄-
368 FET and Cr/Co₃O₄-FET show different degrees of higher responses to C₆H₆, NO₂ and
369 HCHO, respectively. It is shown that the modifications of different NMNPs change the
370 gas sensing responses of the gas sensor to different gases. The dynamic
371 response/recovery curves of four gas sensor units to 0.5-9 ppm gases (HCHO, C₇H₈,
372 NH₃, NO₂ and C₆H₆) are further tested, as shown in Fig. S5. Based on data in Fig. S5,
373 20 response curves of the four gas sensor units to the five gases of different

374 concentrations are obtained, as shown in Fig. 5c. The response of the gas sensor array
375 to the five gases is obviously different at high concentration. However, due to the great
376 difference in the response of the gas sensor array at the high concentration and low
377 concentration gases, the response curves of that at low concentration coincide. But as
378 can be seen in the inset, the gas sensor array also responds significantly differently to
379 low concentrations of the five gases. In order to more intuitively observe and analyze
380 the response of the gas sensor array to the five gases at different concentrations, a visual
381 response heat map (Fig. 5d) is drawn according to the corresponding response signals
382 in Fig. 5c.

383 Based on the experimental data, the correlations between the multiple gas-sensing
384 parameters and gas species and concentrations are established, and an identification
385 strategy are proposed. When the gas sensor array is exposed to gas G_x of unknown
386 species (the range of the species: HCHO, C₇H₈, NH₃, NO₂, and C₆H₆) and unknown
387 concentration (concentration range: 50 ppb-9 ppm), the four gas sensor units
388 respectively output four response signals s₁, s₂, s₃ and s₄, and locate the distribution
389 position of the four response signals in Fig. 5d, corresponding to the specific gas species
390 and concentration. In order to verify the feasibility of the gas identification strategy, the
391 gas sensor array is exposed to gas sample of unknown species and concentration, and
392 obtain the corresponding response values of the four gas sensor units of the gas sensor
393 array, as shown in Fig. S6. Through positioning and comparison, the test sample data
394 is verified. Although the response values of the Pd/Co₃O₄-FET are slightly different,
395 the response values of the Co₃O₄-FET, Au/Co₃O₄-FET and Cr/Co₃O₄-FET are

396 consistent with the database samples, comprehensively evaluating and determining the
397 unknown gas as 2 ppm C_6H_6 . This recognition strategy can eliminate the interference
398 of other gases to realize the accurate recognition of a single unknown gas, and the
399 recognition accuracy of gas is up to 97.51%.

400 **Conclusions**

401 To sum up, in this work, the CNTs are used as the channel material of FET, and the
402 wafer-scale carbon-based FETs are prepared on the substrate covered by a random
403 network arrangement of CNTs by micro-nano fabrication technology. Based on the
404 inkjet printing technology, a variety of the NMNPs/ Co_3O_4 composite are prepared on
405 the floating-gate FETs as sensing gates, and a floating-gate FET gas sensor array based
406 on multi-sensing gates is constructed. Based on the inherent amplification effect of the
407 FET, the detection limit of the Pd/ Co_3O_4 -FET to gas at room temperature is as low as
408 80 ppb, and the gas sensor has better sensitivity and repeatability. In addition, different
409 NMNPs are introduced to adjust the selectivity of the gas sensor, and the correlations
410 between multiple parameters produced by different gas sensor array units and gas
411 species and concentrations are established. The identification accuracy of C_7H_8 , C_6H_6 ,
412 HCHO, NH_3 and NO_2 is achieved with 97.51%. This work provides a new solution for
413 the design of micro-integrated gas sensor array chip which has the ability of trace gas
414 detection and high gas recognition.

415

416 **Author Contributions (optional)**

417 **Qiaoqiao Zou:** Methodology, Formal analysis, Investigation, Resources, Data
418 Curation, Writing - Original Draft, Visualization. **Bin Liu:** Writing - Review & Editing.
419 **Yong Zhang:** Conceptualization, Supervision, Conceptualization, Project
420 administration, Funding acquisition.

421 **Conflicts of interest**

422 The authors declare that they have no conflict of interest.

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